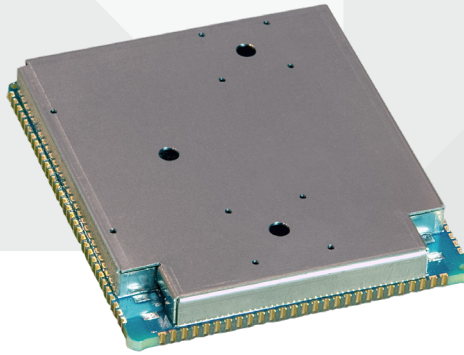




Connect this device with
Digi ConnectCore Cloud Services.
Create. Configure. Deploy. Manage.

DIGI CONNECTCORE 8X

Intelligent and connected embedded system-on-module based on the NXP i.MX 8X with scalable dual/quad-core performance for industrial IoT applications

Digi ConnectCore® 8X delivers a secure and cost-effective connected system-on-module platform that measures in at just 40 mm x 45 mm.

The Digi SMTplus® surface mount form factor allows you to choose simplified design integration leveraging proven and easy-to-use edge-castellated SMT technology, or a versatile LGA option for ultimate design flexibility with access to virtually all interfaces.

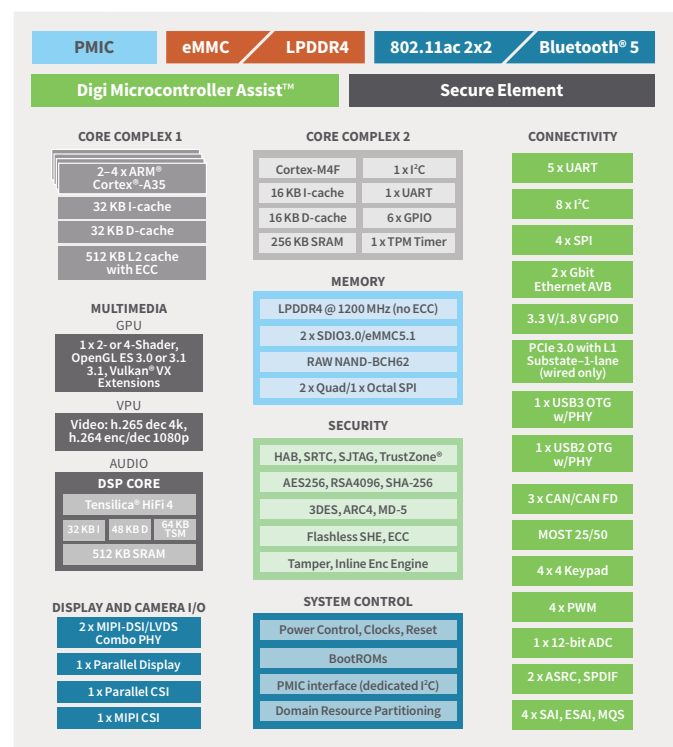
Built on the NXP® i.MX 8X application processor, the module is the intelligent communication engine for today's secure connected devices. Digi ConnectCore 8X can help jump-start the development of streaming video/audio devices, voice control and general human-machine interface solutions.

With a multitude of high performance interconnecting options, including 1x USB 3.0 port, dual Gigabit Ethernet, PCIe 3.0, and pre-certified dual-band 2x2 MU-MIMO WLAN, Digi ConnectCore 8X is ideal for developing a wide range of embedded and IoT applications.

BENEFITS

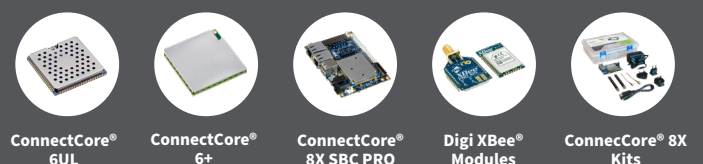
- Industrial i.MX 8X quad/dual-core SOM and SBC platform family
- Digi SMTplus® form factor (40 mm x 45 mm) for ultimate reliability and design freedom
- Power management with both hardware and software support for low-power designs
- Multi-display and camera capabilities with hardware acceleration
- Pre-certified dual-band 802.11a/b/g/n/ac 2x2 and Bluetooth® 5 connectivity
- Seamless cellular modem and Digi XBee® 3 integration
- Cloud and edge-compute services integration
- Built-in device security with Digi TrustFence®
- Remote management with Digi ConnectCore® Cloud Services
- Digi Embedded Yocto Linux® and Android support

BLOCK DIAGRAM



(See table for Dual SOM differences)

RELATED PRODUCTS



SPECIFICATIONS	DIGI CONNECTCORE 8X QUAD	DIGI CONNECTCORE 8X DUAL
APPLICATION PROCESSOR	NXP® i.MX8QuadXPlus • 4x Cortex®-A35 cores at 1.2 GHz • 1x Cortex-M4F at 266 MHz core for real-time processing • 1x Tensilica® Hi-Fi 4 DSP	NXP® i.MX8DualXZ • 2x Cortex®-A35 cores at 1.2 GHz
MEMORY	Up to 64 GB eMMC, up to 4 GB of LPDDR4	
PMIC	NXP PF8100	
GRAPHICS	Multi-stream-capable HD video engine with H.265 (4Kp30), H.264 (1080p60), VP6/VP8 (1080p60), MPEG-2 (1080p60), MPEG4 (1080p), RealVideo (1080p) decode and H.264 (1080p30) encode; 3D video playback in HD in high-performance families; Superior 3D graphics performance with up to four shaders	H.264 (1080p60), VP6/VP8 (1080p60), MPEG-2 (1080p60), MPEG4 (1080p), RealVideo (1080p) decode and H.264 (1080p30) encode; 3D video playback in HD in high-performance families; Superior 3D graphics performance with up to four shaders
SECURITY	Digi TrustFence®, TRNG, TrustZone, ciphers, security control, secure RTC, secure JTAG, eFuses (OTP)	
PERIPHERALS/INTERFACES**	1x SD 3.0 card interface handles SD/SDIO/MMC protocols (1x additional one reserved on the SOM for supporting eMMC); 5x UARTs (4x UARTs from Cortex-A35 core, 1x UART from Cortex-M4); 8x I ² C (4x I ² C high-speed DMA support 4x I ² C low-speed no DMA support); 4x SPI, 1x ESAI, 4x SAI/I ² S/SSI/AC97, S/PDIF Tx/Rx, 3x FlexCAN, MLB150 + DTCP, USB 3.0 OTG with PHY, USB 2.0 OTG with PHY; 4x PWM, GPIO, Keypad, PCIe 3.0 (x1 lane)*, 2x MIPI DSI/LVDS, MIPI CSI, 8/10-bit CSI; 24-bit RGB, RTC, Watchdog, Timers, JTAG	1x SD 3.0 card interface handles SD/SDIO/MMC protocols (1x additional one reserved on the SOM for supporting eMMC); 5x UARTs (4x UARTs from Cortex-A35 core, 1x UART from Cortex-M4); 8x I ² C (4x I ² C high-speed DMA support 4x I ² C low-speed no DMA support); 4x SPI, 1x ESAI, 4x SAI/I ² S/SSI/AC97, S/PDIF Tx/Rx, 3x FlexCAN, MLB150 + DTCP, USB 2.0 OTG with PHY; 4x PWM, GPIO, Keypad, PCIe 3.0 (x1 lane)*, 1x MIPI DSI/LVDS, MIPI CSI, 8/10-bit CSI; 24-bit RGB, RTC, Watchdog, Timers, JTAG
ETHERNET	2x 10/100/1000M Ethernet + AVB	
WI-FI	802.11a/b/g/n/ac: 2.412 - 2.484 GHz, 4.900 - 5.850 GHz 802.11b: 1, 2, 5.5, 11 Mbps (17 dBm typical ±2 dBm) 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps (15 dBm typical ±2 dBm) 802.11n: 15, 30, 45, 60, 90, 120, 135, 150 Mbps (12 dBm typical ±2 dBm) HT40, MCS 0-7 802.11ac: 15, 30, 45, 60, 90, 120, 135, 150, 180, 200 Mbps (10 dBm typical ±2 dBm) HT40, MCS 0-9 Note: All data rates provided above are for 1x spatial stream (double the data rate for 2x spatial streams) Security: WEP, WPA-PSK/WPA2 personal, WPA/WPA2 enterprise, 802.11i, access point mode (up to 10 clients), Wi-Fi Direct Industry certifications: Wi-Fi Alliance Logo Certification Ready, CCxv4 ASD Ready	
BLUETOOTH®	Bluetooth® 5	
ON-MODULE MICROCONTROLLER ASSIST	Digi Microcontroller Assist™ • Independent Cortex-M0+ microcontroller subsystem • Supporting ultra-low power modes at <3 µA	
OPERATING TEMPERATURE	Industrial: -40 °C to 85 °C (-40 °F to 185 °F), depending on use case and enclosure/system design	
STORAGE TEMPERATURE	-50 °C to 125 °C (-58 °F to 257 °F)	
RELATIVE HUMIDITY	5% to 90% (non-condensing)	
RADIO APPROVALS	US, Canada, EU, Japan, Australia/New Zealand	
EMISSIONS/IMMUNITY/SAFETY	FCC Part 15 Class B, EN 55022 Class B, EN 61000-3-2, EN 61000-3-3, ICES- 003 Class B, VCCI Class II, AS 3548, FCC Part 15 Subpart C Section 15.247, IC (Industry Canada), RSS-210 Issue 5 Section 6.2.2(o), EN 300 328, EN 301 489-17, EN 55024, EN 301 489-3, Safety (IEC 62368-1)	
DESIGN VERIFICATION	Temperature: IEC 60068-2-1, IEC 60068-2-2, IEC 60068-2-78 Vibration/shock: IEC 60068-2-6, IEC 60068-2-64, IEC 60068-2-27, HALT	
MECHANICAL DIMENSIONS	118 castellated vias, LGA-474, 1.27 mm pitch, fully shielded for radio emissions and thermal management (heat-spreading) 40 mm x 45 mm x 5.4 mm (1.6 in x 1.8 in x 0.21 in)	
PRODUCT WARRANTY	3-year	

*PCIe is only supported on wired variants.

**Each single PHY can either be a 1 x 4 lane MIPI-DSI or a 1 x 1 channel LVDS interface for a total of 2 display interfaces. In combination, the two PHYs can be configured to be a single 2-channel LVDS interface.

PART NUMBERS	DIGI CONNECTCORE 8X DEVELOPMENT KITS
C-WMX8-KIT	Digi ConnectCore® 8X SBC Pro development kit - SBC PRO baseboard with Digi ConnectCore 8X module, Pico-ITX (100 x 72 mm), industrial temp, 16 GB eMMC, 2 GB LPDDR4, dual 1 Gbit Ethernet, 802.11a/b/g/n/ac 2x2, Bluetooth® 5, Digi XBee® socket, cellular connectivity support via PCI Express Mini Card, SIM, microSD, USB Host, USB OTG, UART, DualCAN, SPI, I2 C, LVDS, camera, antenna connector, battery connector, UART console cable, power supply and antennas, software support for Yocto Project Linux® and Android™, Digi Microcontroller Assist™

PART NUMBERS	DIGI CONNECTCORE 8X SBC PRO
CC-SBP-WMX-JM8E	Digi ConnectCore 8X SBC Pro - i.MX8QuadXPlus, 1.2 GHz, -40 °C to 85 °C (-40 °F to 185 °F), 16 GB flash, 2 GB LPDDR4, 802.11a/b/g/n/ac 2x2, Bluetooth 5, dual Gigabit Ethernet

PART NUMBERS	DIGI CONNECTCORE 8X SYSTEM-ON-MODULES
DIGI CONNECTCORE 8X QUAD SOMS	
CC-MX-JM7D-ZN	Digi ConnectCore 8X SOM - Digi ConnectCore8X SOM QuadXPlus 1.2 GHz, 8 GB eMMC, 1 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F)
CC-MX-JM8D-ZN	Digi ConnectCore 8X SOM - Digi ConnectCore 8X SOM QuadXPlus 1.2 GHz, 8 GB eMMC, 2 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F)
CC-WMX-JM7D-NN	Digi ConnectCore 8X SOM - Digi ConnectCore 8X SOM QuadXPlus 1.2 GHz, 8 GB eMMC, 1 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F), 802.11a/b/g/n/ac 2x2, Bluetooth 5
CC-WMX-JM8E-NN	Digi ConnectCore 8X SOM - Digi ConnectCore8X SOM QuadXPlus 1.2 GHz, 16 GB eMMC, 2 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F), 802.11a/b/g/n/ac 2x2, Bluetooth 5
DIGI CONNECTCORE 8X DUAL SOMS	
CC-MX-JQ6D-ZN	Digi ConnectCore 8X SOM - Digi ConnectCore 8X SOM DualXZ 1.2 GHz, 8 GB eMMC, 512 MB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F)
CC-MX-JQ7D-ZN	Digi ConnectCore 8X SOM - Digi ConnectCore 8X SOM DualXZ 1.2 GHz, 8 GB eMMC, 1 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F)
CC-WMX-JQ7D-ZN	Digi ConnectCore 8X SOM - Digi ConnectCore 8X SOM DualXZ 1.2 GHz, 8 GB eMMC, 1 GB LPDDR4, -40 °C to 85 °C (-40 °F to 185 °F), 802.11a/b/g/n/ac 2x2, Bluetooth 5

PART NUMBERS	DIGI CONNECTCORE 8X ACCESSORIES
CC-ACC-LCDH-10	LCD application kit, including 10 in WXGA (High Resolution)

PART NUMBERS	DIGI CONNECTCORE CLOUD SERVICES
CC-CS-ESS-1-1YR	Digi ConnectCore Cloud Services — Essential 1-year (1 device)
CC-CS-ESS-100-1YR	Digi ConnectCore Cloud Services — Essential 1-year (100 devices)
CC-CS-ESS-100-3YR	Digi ConnectCore Cloud Services — Essential 3-year (100 devices)
CC-CS-ESS-100-5YR	Digi ConnectCore Cloud Services — Essential 5-year (100 devices)
CC-CS-PRM-1-1YR	Digi ConnectCore Cloud Services — Premium 1-year (1 device)
CC-CS-PRM-100-1YR	Digi ConnectCore Cloud Services — Premium 1-year (100 devices)
CC-CS-PRM-100-3YR	Digi ConnectCore Cloud Services — Premium 3-year (100 devices)
CC-CS-PRM-100-5YR	Digi ConnectCore Cloud Services — Premium 5-year (100 devices)

PART NUMBERS	DIGI CONNECTCORE SECURITY SERVICES
CC-SEC-ESS	Digi ConnectCore Security Services — Essential 1-year
CC-SEC-PRM	Digi ConnectCore Security Services — Premium 1-year
CC-SEC-ENT	Digi ConnectCore Security Services — Enterprise 1-year
CC-SEC-ENT-ADD	Digi ConnectCore Security Services — Additional product (same duration as main contract)

PART NUMBERS	EXPERT SUPPORT
DG-EXPE-12	Expert 12x5 support for end users
DG-EXPE-24	Expert 24x7 support for end users

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DIGI INTERNATIONAL WORLDWIDE HQ
877-912-3444 / 952-912-3444 / www.digi.com

DIGI INTERNATIONAL JAPAN
+81-3-5428-0261 / www.digi-intl.co.jp

DIGI INTERNATIONAL GERMANY
+49-89-540-428-0

DIGI INTERNATIONAL SINGAPORE
+65-6213-5380

DIGI INTERNATIONAL CHINA
+86-21-50492199 / www.digi.com.cn

